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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
VDS	Drain-source voltage	600	V
V _{DGR}	Drain-gate voltage (R_{GS} = 20 k Ω)	600	V
Vgs	Gate-source voltage	±30	V
ID	Drain current (continuous) at T _C = 25 °C	1.0	Α
ID	Drain current (continuous) at T _C = 100 °C	0.63	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	4	А
Ртот	Total dissipation at $T_C = 25 \ ^{\circ}C$	30	W
I _{AR}	Avalanche current, repetitive or not-repetitive (pulse width limited by T _{jmax})	1	А
Eas	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$, $V_{DD} = 50$ V)		mJ
dv/dt (2)	r/dt ⁽²⁾ Peak diode recovery voltage slope		V/ns
Tj	Operating junction temperature range	55 to 150	ŝ
T _{stg}	T _{stg} Storage temperature range		Ĵ

Notes:

⁽¹⁾Pulse width limited by safe operating area.

 $^{(2)}I_{SD} \leq$ 1.0 A, di/dt \leq 100 A/µs; V_DD \leq V(BR)DSS, TJ \leq TJMAX

Table	3:	Thermal	data
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Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	4.2	°C/W
R _{thj-amb}	Thermal resistance junction-ambient		°C/W



 $T_C = 25$ ° C unless otherwise specified

Table 4: On/off-state						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 V$, $I_D = 1 mA$	600			V
	7	$V_{GS} = 0 V, V_{DS} = 600 V$			1	μA
I _{DSS}	Zero gate voltage drain current	$V_{GS} = 0 V, V_{DS} = 600 V$ T _c = 125 °C ⁽¹⁾			50	μA
I _{GSS}	Gate body leakage current	V_{DS} =0 V, V_{GS} = ±30 V			±100	nA
VGS(th)	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2.25	3	3.7	V
RDS(on)	Static drain-source on- resistance	$V_{GS}=10~V,~I_D=0.5~A$		7.3	8.5	Ω

Notes:

⁽¹⁾Defined by design, not subject to production test.

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	156	-	pF
Coss	Output capacitance	$V_{DS} = 25 V f = 1 MHz V_{CS} = 0 V$	-	23.5	-	pF
C _{rss}	Reverse transfer capacitance	VDS - 20 V, I - I WII 2, VGS - 0 V		3.8	-	рF
Qg	Total gate charge	V _{DD} = 480 V, I _D = 1 A	-	7	-	nC
Qgs	Gate-source charge	V _{GS} = 0 to 10 V	-	1.1	-	nC
Q _{gd}	Gate-drain charge	(see Figure 16: "Test circuit for gate charge behavior")	-	3.7	-	nC

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD}\text{=}$ 300 V, I_{D} = 0.5 A, R_{G} = 4.7 Ω	-	6.5	-	ns
tr	Rise time	V _{GS} = 10 V	-	5	-	ns
t _{d(off)}	Turn-off delay time	(see Figure 15: "Test circuit for resistive load switching times" and	-	19	-	ns
tŗ	Fall time	Figure 20: "Switching time waveform")	-	25	-	ns

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	Table 7: Source-drain diode						
Symbol	Symbol Parameter Test conditions		Min.	Тур.	Max.	Unit	
Isd	Source-drain current		-		1	А	
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		4	А	
Vsd ⁽²⁾	Forward on voltage	$I_{SD} = 1.0 \text{ A}, V_{GS} = 0 \text{ V}$	-		1.6	V	
trr	Reverse recovery time	I _{SD} = 1.0 A, di/dt = 100 A/µs,	-	140		ns	
Qrr	Reverse recovery charge	V _{DD} = 25 V (see Figure 17: "Test circuit for inductive load switching and diode recovery times")		240		nC	
I _{RRM}	Reverse recovery current			3.3		А	
trr	Reverse recovery time	I _{SD} = 1.0 A, di/dt = 100 A/µs,	-	229		ns	
Qrr	Reverse recovery charge	$V_{DD} = 25 \text{ V}, \text{ T}_{j} = 150 ^{\circ}\text{C}$ (see Figure 17: "Test circuit for inductive load switching and diode recovery times")		377		nC	
IRRM	Reverse recovery current			3.3		A	

Notes:

 $^{(1)}\mbox{Pulse}$ width limited by safe operating area

 $^{(2)}\text{Pulsed:}$ pulse duration = 300 μ s, duty cycle 1.5%









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Electrical characteristics







STD1NK60-1





3 Test circuits







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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 IPAK (TO-251) type A package information







Package information

Table 8: IPAK (TO-251) type A package mechanical data						
Dim	mm					
Dini.	Min.	Тур.	Max.			
A	2.20		2.40			
A1	0.90		1.10			
b	0.64		0.90			
b2			0.95			
b4	5.20		5.40			
B5		0.30				
С	0.45		0.60			
c2	0.48		0.60			
D	6.00		6.20			
E	6.40		6.60			
е		2.28				
e1	4.40		4.60			
н		16.10				
L	9.00		9.40			
L1	0.80		1.20			
L2		0.80	1.00			
V1		10°				



4.2 IPAK (TO-251) type C package information







Package information

Table 9: IPAK (TO-251) type C package mechanical data				
Dim		mm		
Dim.	Min.	Тур.	Max.	
A	2.20	2.30	2.35	
A1	0.90	1.00	1.10	
b	0.66		0.79	
b2			0.90	
b4	5.23	5.33	5.43	
С	0.46		0.59	
c2	0.46		0.59	
D	6.00	6.10	6.20	
D1	5.20	5.37	5.55	
E	6.50	6.60	6.70	
E1	4.60	4.78	4.95	
е	2.20	2.25	2.30	
e1	4.40	4.50	4.60	
н	16.18	16.48	16.78	
L	9.00	9.30	9.60	
L1	0.90	1.00	1.20	
L2	0.90	1.08	1.25	
θ1	3°	5°	7°	
θ2	1°	3°	5°	



5 Revision history

Table 10: Document revision history

Date	Revision	Changes
09-Feb-2017	1	First release.



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